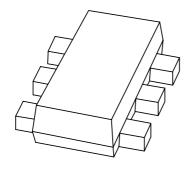
DISCRETE SEMICONDUCTORS

DATA SHEET



BAT960Schottky barrier diode

Preliminary specification

2002 Jun 24





BAT960

FEATURES

- · High current capability
- · Very low forward voltage
- Ultra small plastic SMD package
- Flat leads: excellent coplanarity and improved thermal behaviour.

APPLICATIONS

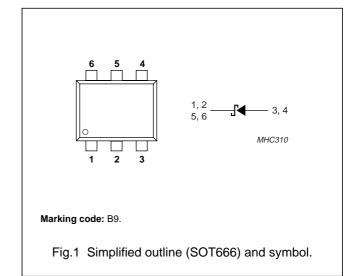
- · Ultra high-speed switching
- rectification
- DC/DC conversion
- Switch mode power supply
- Inverse polarity protection.

GENERAL DESCRIPTION

Planar Schottky barrier diode with an integrated guard ring for stress protection in a SOT666 ultra small SMD plastic package.

PINNING

PIN	DESCRIPTION			
1	cathode			
2	cathode			
3	anode			
4	anode			
5	cathode			
6	cathode			



LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 60134).

SYMBOL	PARAMETER	PARAMETER CONDITIONS			
V _R	continuous reverse voltage		_	20	V
l _F	continuous forward current		_	1	А
I _{FSM}	non-repetitive peak forward current	t = 8.3 ms half sinewave; JEDEC method; note 1	_	8	А
T _{stg}	storage temperature		-65	+150	°C
Tj	junction temperature		_	125	°C
T _{amb}	operating ambient temperature		-65	+125	°C

Note

1. Only valid, if pins 3 and 4 are connected in parallel.

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THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	CONDITIONS	VALUE	UNIT
R _{th j-a}	thermal resistance from junction to ambient	note 1	405	K/W
		note 2	215	K/W

Notes

- 1. Refer to SOT666 standard mounting conditions.
- 2. Mounted on printed circuit-board, 1 cm² copper area.

Soldering

The only recommended soldering method is reflow soldering.

CHARACTERISTICS

 T_{amb} = 25 °C unless otherwise specified.

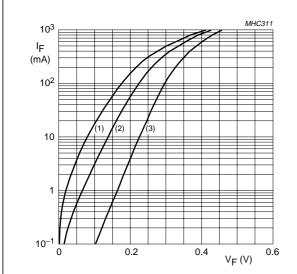
SYMBOL	PARAMETER	CONDITIONS	TYP.	MAX.	UNIT
V _F	continuous forward voltage	I _F = 10 mA	240	270	mV
		I _F = 100 mA	300	350	mV
		I _F = 1000 mA; note 1; see Fig.2	480	550	mV
I _R	reverse current	V _R = 5 V; note 2	5	10	μΑ
		V _R = 8 V; note 2	7	20	μΑ
		V _R = 15 V; note 2; see Fig.3	10	50	μΑ
C _d	diode capacitance	V _R = 5 V; f = 1 MHz; see Fig.4	19	25	pF

Notes

- 1. Only valid, if pins 1, 2, 5 and 6 are soldered on a 1 cm² copper solder land.
- 2. Pulse test: $t_p = 300 \ \mu s$; $\delta = 0.02$.

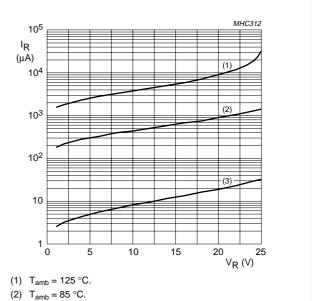
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GRAPHICAL DATA



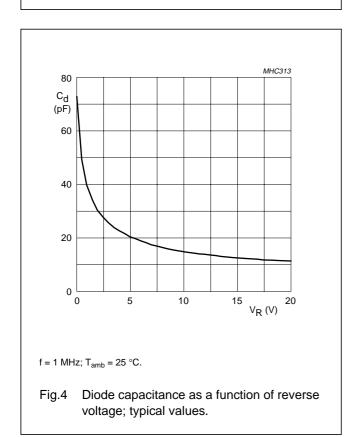
- (1) $T_{amb} = 125 \, ^{\circ}C$.
- (2) $T_{amb} = 85 \, ^{\circ}C$.
- (3) $T_{amb} = 25 \, ^{\circ}C$.

Fig.2 Forward current as a function of forward voltage; typical values.



- (3) $T_{amb} = 25 \, ^{\circ}C$.

Fig.3 Reverse current as a function of reverse voltage; typical values.



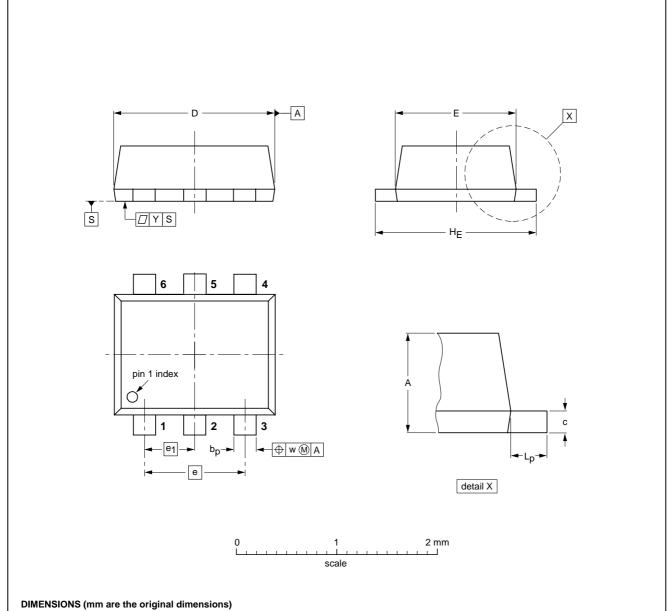
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PACKAGE OUTLINE

Plastic surface mounted package; 6 leads

SOT666



UNIT	Α	bp	С	D	E	е	e ₁	HE	L _p	w	у
mm	0.6 0.5	0.27 0.17	0.18 0.08	1.7 1.5	1.3 1.1	1.0	0.5	1.7 1.5	0.3 0.1	0.1	0.1

OUTLINE		REFER	EUROPEAN	ISSUE DATE		
VERSION	IEC	JEDEC	EIAJ		PROJECTION	ISSUE DATE
SOT666						-01-01-04 01-08-27

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Schottky barrier diode

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DATA SHEET STATUS

DATA SHEET STATUS(1)	PRODUCT STATUS ⁽²⁾	DEFINITIONS
Objective data	Development	This data sheet contains data from the objective specification for product development. Philips Semiconductors reserves the right to change the specification in any manner without notice.
Preliminary data	Qualification	This data sheet contains data from the preliminary specification. Supplementary data will be published at a later date. Philips Semiconductors reserves the right to change the specification without notice, in order to improve the design and supply the best possible product.
Product data	Production	This data sheet contains data from the product specification. Philips Semiconductors reserves the right to make changes at any time in order to improve the design, manufacturing and supply. Changes will be communicated according to the Customer Product/Process Change Notification (CPCN) procedure SNW-SQ-650A.

Notes

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